



N-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
	0.0053 at V _{GS} = 4.5 V	21.5				
12	0.006 at V _{GS} = 2.5 V	20.2	29.5 nC			
	0.0074 at V _{GS} = 1.8 V	18.2				

SO-8 S 1 8 D S 2 7 D S 3 6 D Top View

Ordering Information: Si4866BDY-T1-E3 (Lead (Pb)-free)

Si4866BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

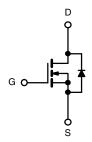
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

ROHS COMPLIANT HALOGEN FREE Autiliable

APPLICATIONS

- Synchronous Rectifier
- Point-of-Load Synchronous Buck Converter



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, unles	ss otherwise no	ted	
Parameter	Symbol Limit		Unit	
Drain-Source Voltage	V_{DS}	12	V	
Gate-Source Voltage	V _{GS}	± 8		
	T _C = 25 °C		21.5	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I_	17.2	
Continuous Diam Current (1) = 130 C)	T _A = 25 °C	I _D	16.1 ^{b,c}	
	T _A = 70 °C		12.9 ^{b,c}	^
Pulsed Drain Current	I _{DM}	50	A	
Continuous Course Drain Diade Current	T _C = 25 °C	I.	4.0	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.3 ^{b,c}	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20	
Avalanche Energy	L = 0.1 mm	E _{AS}	20	mJ
	T _C = 25 °C		4.45	
Marianua Parray Dissination	T _C = 70 °C	ь	2.85	14/
Maximum Power Dissipation	T _A = 25 °C	P _D	2.50 ^{b,c}	w
	T _A = 70 °C		1.6 ^{b,c}	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b,d}	t ≤ 10 s	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	23	28		

Notes

- a. Based on T_{C} = 25 $^{\circ}C.$
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 90 °C/W.

Si4866BDY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-				L	L	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	12			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		12		m\//06	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.4		1.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Wallana Busin Oursel	I _{DSS}	V _{DS} = 12 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		V _{DS} = 12 V, V _{GS} = 0 V, T _J = 55 °C	= 12 V, V _{GS} = 0 V, T _J = 55 °C		10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α	
		V _{GS} = 4.5 V, I _D = 12 A		0.0042	0.0053		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 10 A	_		0.0060	Ω	
	, ,	$V_{GS} = 1.8 \text{ V}, I_D = 8 \text{ A}$		0.006	0.0074	1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 12 A		80		S	
Dynamic ^b				L	l	<u>I</u>	
Input Capacitance	C _{iss}			5020			
Output Capacitance	C _{oss}	V _{DS} = 6 V, V _{GS} = 0 V, f = 1 MHz		1305		pF	
Reverse Transfer Capacitance	C _{rss}	30 00		805			
· · · · · · · · · · · · · · · · · · ·		V _{DS} = 6 V, V _{GS} = 4.5 V, I _D = 10 A		52	80	nC	
Total Gate Charge	Q_g			29.5	45		
Gate-Source Charge	Q _{gs}	$V_{DS} = 6 \text{ V}, V_{GS} = 2.5 \text{ V}, I_{D} = 10 \text{ A}$		6.2			
Gate-Drain Charge	Q _{gd}			8.9			
Gate Resistance	R_g	f = 1 MHz		0.8	1.3	Ω	
Turn-On Delay Time	t _{d(on)}			26	40		
Rise Time	t _r	$V_{DD} = 6 \text{ V}, R_{L} = 1.2 \Omega$		18	30		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		85	130	1	
Fall Time	t _f			32	50		
Turn-On Delay Time	t _{d(on)}			13	25	ns	
Rise Time	t _r	$V_{DD} = 6 \text{ V}, R_{L} = 1.2 \Omega$		12	24		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		57	90		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristic	cs	1		L			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4		
Pulse Diode Forward Current ^a	I _{SM}				50	Α	
Body Diode Voltage	V_{SD}	I _S = 2.3 A		0.62	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			50	80	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	0.5 A 31/31 400 A / T 55 30		35	55	nC	
Reverse Recovery Fall Time	t _a	$I_F = 9.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		19			
Reverse Recovery Rise Time	t _b			31		ns	

Notes:

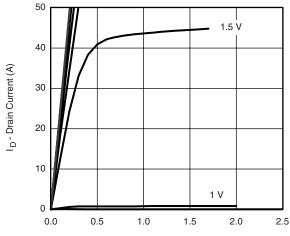
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

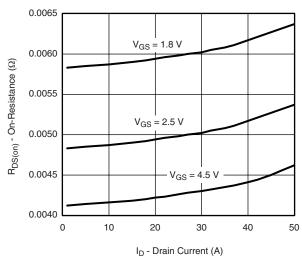
b. Guaranteed by design, not subject to production testing.



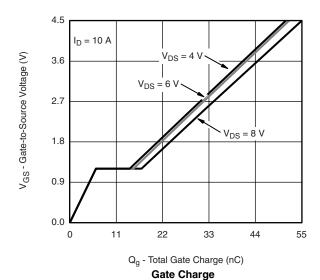
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





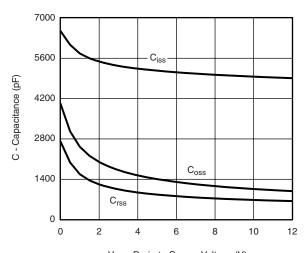


On-Resistance vs. Drain Current and Gate Voltage



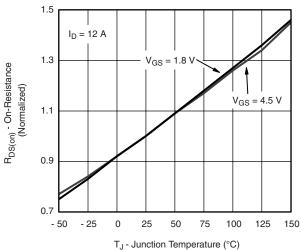
2.0 1.6 I_D - Drain Current (A) 25 °C 1.2 0.8 T_C = 125 °C 0.4 - 55 °C 0.0 0.0 0.3 0.6 0.9 1.2 1.5

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



V_{DS} - Drain-to-Source Voltage (V)



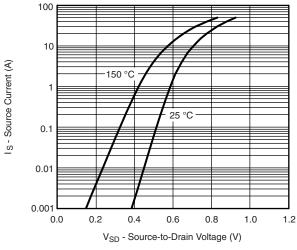


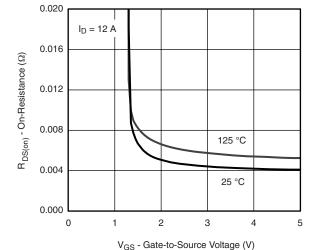
On-Resistance vs. Junction Temperature

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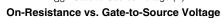
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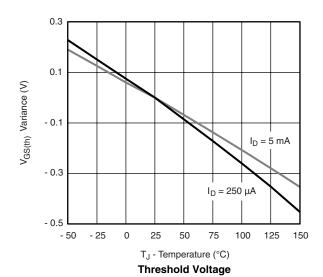
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

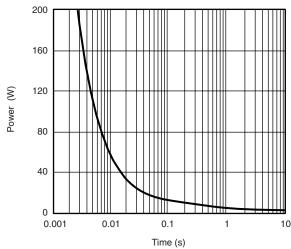




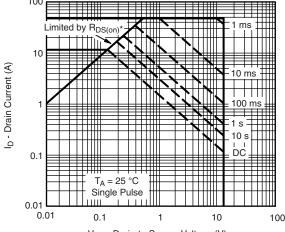
Source-Drain Diode Forward Voltage







Single Pulse Power, Junction-to-Ambient

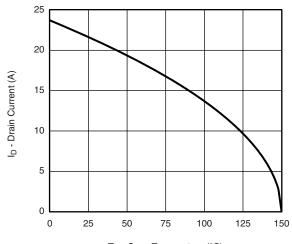


 $V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^*V_{GS} > \text{minimum V}_{GS} \text{ at which R}_{DS(on)} \text{ is specified}$

Safe Operating Area, Junction-to-Ambient

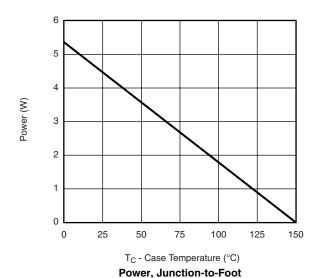


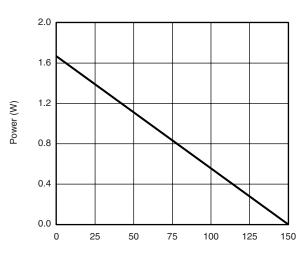
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*





T_A - Ambient Temperature (°C)

Power, Junction-to-Ambient

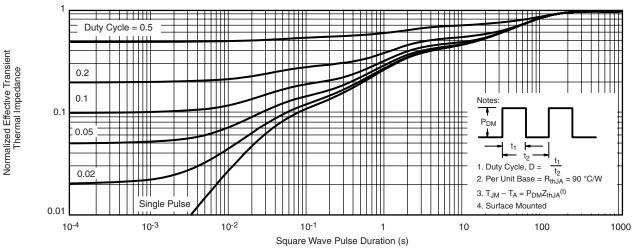
Document Number: 70341 S09-0540-Rev. B, 06-Apr-09

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

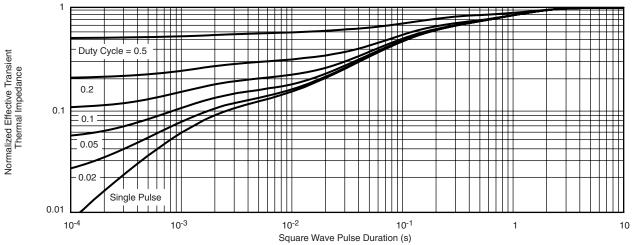
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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